LAW OFFICES

EPSTEIN & GERKEN

1901 RESEARCH BOULEVARD SUITE 340

ROCKVILLE, MARYLAND 20850-3164

ROBERT H. EPSTEIN*+ KAREN M. GERKEN

TELEPHONE (301) 610-7634

OF COUNSEL ROBERT N. LEVIN AARON B. RETZER*+ FACSIMILE (301) 610-9569

VIRGINIA OFFICE 2341 JEFFERSON DAVIS HWY SUITE 112 ARLINGTON, VIRGINIA 22202

VA BAR F DC BAR

FACSIMILE TRANSMISSION TO USPTO

Date: Monday, February 10, 2003

To: Examiner William T. Leader

U.S. Patent and Trademark Office

Group Art Unit 1741

Facsimile Tel. No.: 703-872-9611

Number of Pages (including cover sheet) 3

From: Robert H. Epstein

e-mail: rhe@epsteingerken.com

If any difficulties occur during transmission, please contact Amanda at (301) 610-7634.

Message:

Re:

U.S. Patent Application Serial No.:09/880,715

Applicant: T.L. Ritzdorf et al

Group Art Unit: 1741 Filed: June 12, 2001

Method for Filling Recessed Micro-Structures with

Metallization in the Production of a Microelectronic Device

CERTIFICATE OF TRANSMISSION

I hereby certify that this correspondence is being transmitted by facsimile to the U.S. Patent and Trademark Office on Monday, February 10, 2003.

Robert H. Epstein

Typed or printed name of person signing certificate

Signature

This facsimile is intended only for the individual to whom it is addressed and may contain information that is privileged, confidential or exempt from disclosure under applicable law. If you have received this facsimile in error, please notify us immediately by telephone (collect), and return the original message to us at the above address via the U.S. Postal Service.